

DATASHEET

ELCH08-KB5060J7J9283910-FDX

Received ■ MASS PRODUCTION □ PRELIMINARY □ CUSTOMER DESIGN DEVICE NO. : DHE-0003432 PAGE: 13

Revised record						
REV.	DESCRIPTION	RELEASE DATE				
1	New spec	Nov.23.2017				



ELCH08-KB5060J7J9283910-FDX



Features

- Feature of the device: small package with high efficiency.
- Typical luminous flux@ 1A: 300lm.
- Optical efficiency@1A: 90.2lm/W.
- ESD protection (according to JEDEC 3b) (HBM air or contact discharge) up to 8kV.
- Binning Parameters: brightness, forward voltage and chromaticity.
- Grouping parameter: total luminous flux, color coordinates.
- RoHS compliant & Pb free.
- Compliance with EU REACH.
- Compliance halogen free (Br <900ppm, Cl <900ppm, Br+Cl <1500ppm).

Applications

- Mobile phone camera flash (camera flash light /strobe light for mobile devices).
- Torch light for DV (Digital Video) application.
- Indoor lighting applications.
- Signal and symbol luminaries for orientation maker lights (e.g. steps, exit ways, etc.).
- TFT backlighting.
- Exterior and interior illumination applications.
- Decorative and entertainment lighting.
- Exterior and interior automotive illumination.



Device Selection Guide

Chip Materials	Emitted Color
InGaN	White

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit	
DC Forward Current (Torch Mode)	I_{F}	350	mA	
Peak Pulse Current	I _{Pulse}	1500	mA	
ESD Resistance (JEDEC 3b)	V_{B}	8000	V	
Reverse Voltage	V_R	Note 1	V	
Junction Temperature	T_{J}	150	$^{\circ}\! \mathbb{C}$	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	TStg	-40 ~ +100	$^{\circ}\! \mathbb{C}$	
Soldering Temperature	TSol	260	$^{\circ}\! \mathbb{C}$	
Allowable Reflow Cycles	n/a	3	Cycles	
Viewing Angle ₍₂₎	$2 heta_{1/2}$	120	Deg	

- 1. The Chin series LEDs are not designed for reverse bias used.
- 2. View angle measurement tolerance $\pm 5^{\circ}$.
- 3. Avoid operating Chin series LEDs at maximum operating temperature exceed 1 hour.
- 4. All specification are assured by reliability test for 1000hrs, IV degradation less than 30%.
- 5. All reliability item are tested under good thermal management with $1.0 \times 1.0 \text{ cm}^2 \text{MCPCB}$.
- **6.** Peak pulse current shall be applied under conditions as max duration time 400ms and max duty cycle 10%.
- 7. Operate LED component at maximum rating conditions continuously will cause possible permanent damage and de-rating parameters. Exercise multiple maximum rating parameters simultaneously should not be allowed. When maximum rating parameters are applied over a long period will result potential reliability issue.



JEDEC Moisture Sensitivity

Level	Floor Life		Soak Requirements Standard		
Level	Time (hours)	Conditions	Time (hours)	Conditions	
1	Unlimited	≦30°C / 85% RH	168 (+5/-0)	85°C / 85% RH	

Electro-Optical Characteristics (Ts=25 $^{\circ}$ C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux ₍₁₎	Iv	250	300		lm	_
Forward Voltage ₍₂₎₍₃₎	V_{F}	2.85		3.95	V	- I _F =1000mA
Color Temperature	CCT	5000		6000	K	1 _F =1000IIIA
Color Rendering Index ₍₄₎	CRI	80	83			_

Forward Voltage Binning

Bin	Symbol	Min.	Тур.	Max.	Unit	Condition
2832	V_{F}	2.85		3.25		
3235	V_{F}	3.25		3.55	V	$I_F = 1000 \text{mA}$
3539	V_{F}	3.55		3.95		

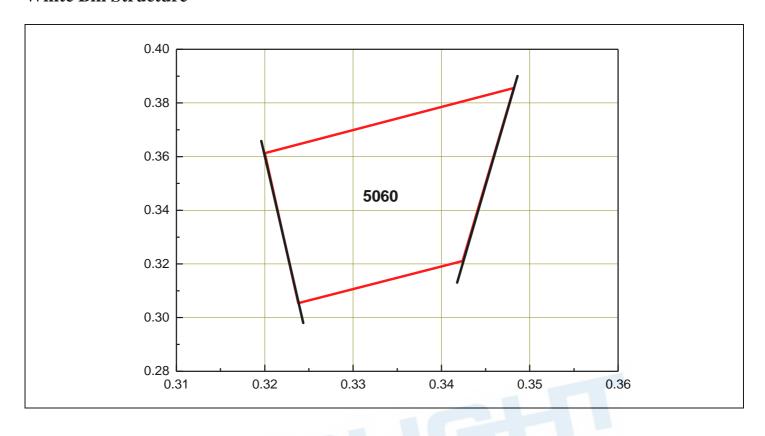
Luminous Flux Binning

Bin	Symbol	Min.	Тур.	Max.	Unit	Condition
J7	Iv	250		300		
J8	Iv	300		330	lm	$I_F = 1000 \text{mA}$
J9	Iv	330		360	_	

- 1. Luminous flux, illuminance measurement tolerance : $\pm 10\%$.
- **2.** Forward voltage measurement tolerance : ± 0.1 V.
- **3.** Electric and optical data is tested at 25ms pulse condition.
- **4.** Color rendering index measurement tolerance: ± 2 .



White Bin Structure

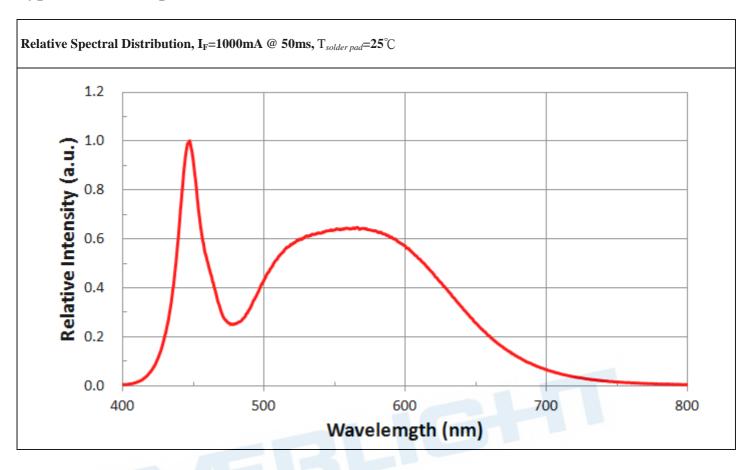


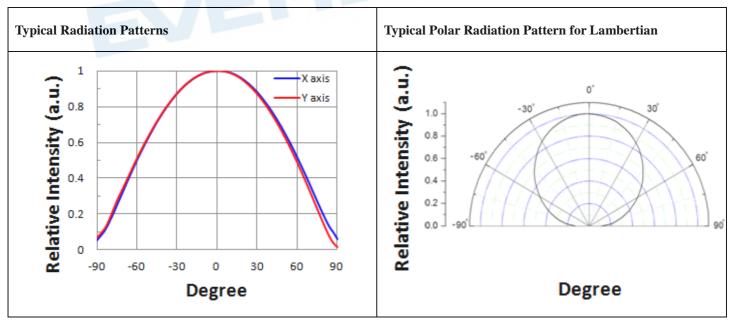
Bin	CIE-X	CIE-Y	Reference Range
5060	0.3200	0.3613	
	0.3482	0.3856	5000 C000V
	0.3424	0.3211	5000~6000K
	0.3238	0.3054	

- **1.** Color coordinates measurement allowance : ± 0.01 .
- 2. Color bins are defined at $I_F = 1000 \text{mA}$ operation.



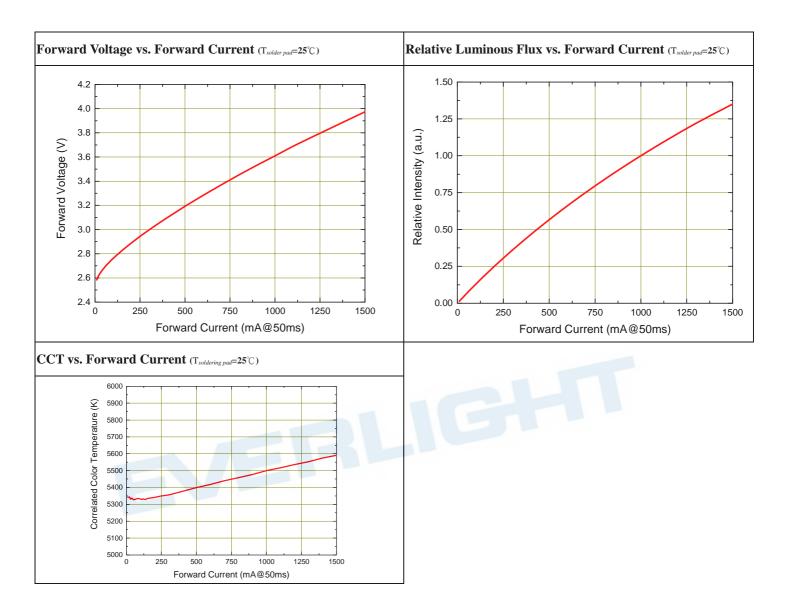
Typical Electro-Optical Characteristics Curves





- 1. $2\theta_{1/2}$ is the off axis from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is $\pm 5^{\circ}$.



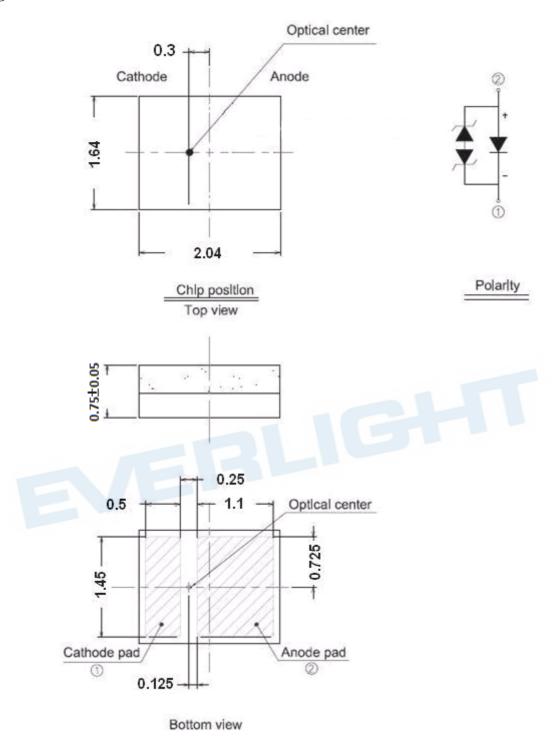


Notes:

1. All correlation data is tested under superior thermal management with 1 x 1 cm² MCPCB.



Package Dimension

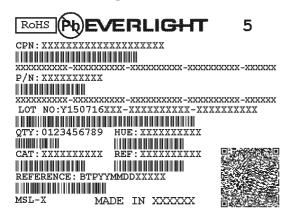


- 1. Dimensions are in millimeter.
- 2. Tolerances unless mentioned are ± 0.1 mm.



Moisture Resistant Packing Materials

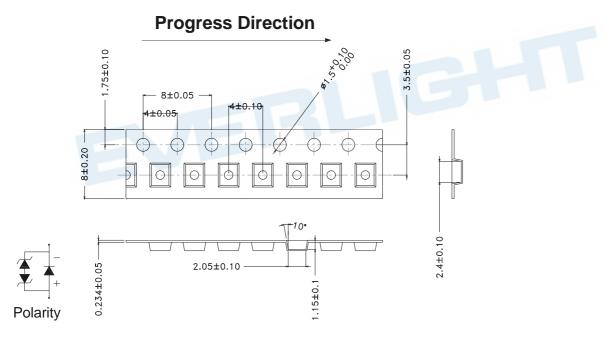
Product Labeling



- CPN: Customer's Product Number
- P/N: Everlight Product Number
- LOT NO: Lot Number
- · QTY: Packing Quantity
- CAT: Luminous Flux (Brightness) Bin
- · HUE: Color Bin
- REF: Forward Voltage Bin
- REFERENCE: Reference
- · MSL-X: MSL Level

Carrier Tape Dimensions: Loaded Quantity 2000pcs per Reel

(Minimum Package Quantity: 1000pcs)

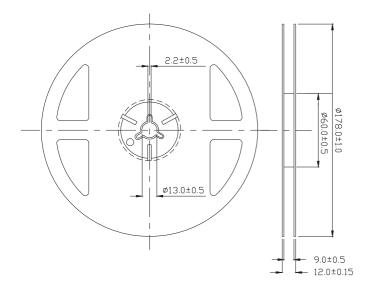


Notes:

1. Dimensions are in millimeter.

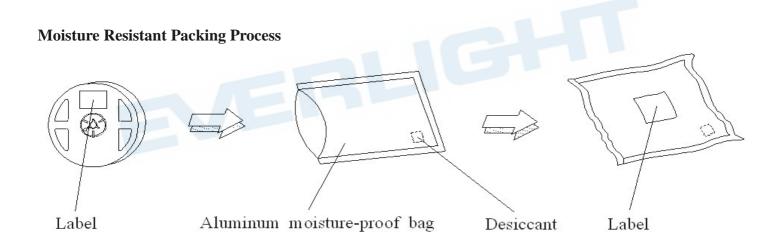


Emitter Reel Dimensions



Notes:

1. Dimensions are in millimeter.





Reflow Soldering Characteristics

Soldering and Handling

1. Over-current-proof

Though CHIN series has conducted ESD protection mechanism, customers must not use the device in reverse and should apply resistors for extra protection. Otherwise, slight voltage shift may cause enormous current shift and burn out failure would happen.

2. Storage

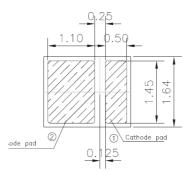
- 2.1 Do not open the moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 90%.
- 2.3 After opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 85%.
- 2.4 If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be implemented based on the following conditions: pre-curing at 60±5°C for 24 hours.

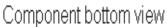
3. Thermal Management

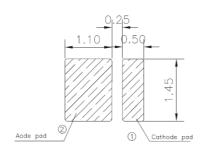
- 3.1 For maintaining the high flux output and achieving reliability, CHIN series LEDs should be mounted on a metal core printed circuit board (MCPCB), with proper thermal connection to dissipate approximately 1W to 5W of thermal energy under normal operation.
- 3.2 Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LEDs lifetime will decrease critically.
- 3.3 When operating, the solder pad temperature (or the board temperature nearby the LED) must controlled under 70°C.

4. Soldering Condition

4.1 Soldering Pad:



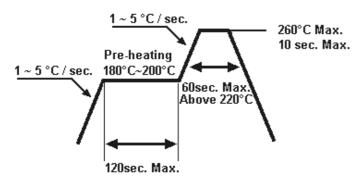




Recommended soldering pattern layout



- 4.2 For Reflow Process
 - 4.2.1 Lead reflow soldering temperature profile:



- 4.2.2 Reflow soldering should not be done more than three times.
- 4.2.3 While soldering, do not put stress on the LEDs during heating.
- 4.2.4 After soldering, do not warp the circuit board.





DISCLAIMER

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- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
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